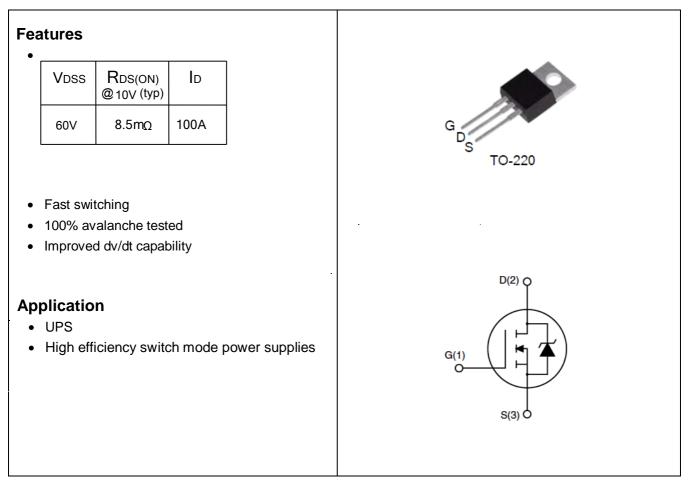
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Description

Absolute Maximum Ratings $T_{c}\text{=}25\,^{\circ}\text{C}$ unless otherwise specified

Symbol	Parameter		Max.	Units	
	Faialleter	TO-220			
V _{DSS}	Drain-Source Voltage		60	V	
V _{GSS}	Gate-Source Voltage		± 20	V	
I _D	Continuous Drain Current	T _C = 25℃	100	A	
		T _C = 100°C	62.6	A	
I _{DM}	Pulsed Drain Current note1		390	A	
lar	Avalanche Current note1		50	A	
Ear	Repetitive Avalanche Energy note1		18	mJ	
dv/dt	Peak Diode Recovery Energy note3		5.0	V/ns	
P _D	Power Dissipation	T _C = 25℃	200	W	
	Linear Derating Factor	T _C > 25℃	1.3	W/°C	
$R_{\theta JC}$	Thermal Resistance, Junction to Case		0.75	°C /W	

T _J , T _{STG} Operating and Storage Temperature Range	-55 to +175	°C
---------------------------------------------------------------------------	-------------	----

*Drain current limited by maximum junction temperature

Electrical Characteristics $T_c=25^{\circ}C$ unless otherwise specified

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
Off Charact	eristic	•		•		
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250 \mu A$	60	-	-	V
$\bigtriangleup V_{(BR)DSS}$	Breakdown Voltage Temperature	Reference to 25℃,	-	0.057	-	V/℃
$/ \triangle T_J$	Coefficient	I _D = 250μA				
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 60V, V_{GS} = 0V$	-	-	1	μA
		V_{DS} = 48V, T_{C} = 125 °C	-	-	10	μA
I _{GSS}	Gate to Body Leakage Current	V_{DS} = 0V, V_{GS} = ±20V	-	-	±100	nA
On Charact	eristics					
$V_{GS(th)}$	Gate Threshold Voltage note4	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2	-	4	V
R _{DS(on)}	Static Drain-Source On-Resistance	V_{GS} =10V, I_{D} = 50A	-	8.5	10	mΩ
g fs	Forward Transconductance	$V_{DS} = 20V, I_D = 50A$	45	-	-	S
Dynamic Cl	haracteristics	·	•			
C _{iss}	Input Capacitance	$V_{DS} = 25V, V_{GS} = 0V,$	-	3291	-	pF
C _{oss}	Output Capacitance		-	671.5	-	pF
C _{rss}	Reverse Transfer Capacitance	f = 1.0MHz	-	112.1	-	pF
Qg	Total Gate Charge	- V _{DD} = 48V, I _D = 50A, - V _{GS} = 10V	-	118	-	nC
Q _{gs}	Gate-Source Charge		-	23.2	-	nC
Q _{gd}	Gate-Drain("Miller") Charge		-	36	-	nC
Eas	Single Pulse Avalanche Energy note2	IAS = 16A, L = 10mH	-	1280 ^{note5}	326 ^{note6}	mJ
Switching (Characteristics			•		
t _{d(on)}	Turn-On Delay Time		-	19.3	-	ns
t _r	Turn-On Rise Time	$V_{DD} = 30V, I_D = 50A,$	-	50.8	-	ns
t _{d(off)}	Turn-Off Delay Time	$R_G = 5\Omega$, $V_{GS} = 10V$	-	55.2	-	ns
t _f	Turn-Off Fall Time		-	24.8	-	ns
Drain-Sour	ce Diode Characteristics and Maximum R	atings				
ls	Maximum Continuous Drain to Source Diode Forward Current		-	-	100	А
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	390	А
V _{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 50A$	-	-	1.3	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0V, I_F = 50A,$	-	62.3	-	ns
Qrr	Reverse Recovery Charge	di/dt =100A/µs	-	182	-	nC

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature

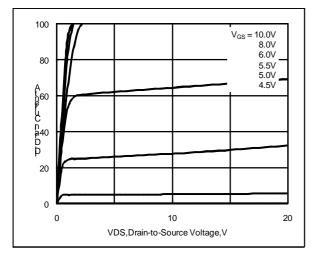
2. L = 10mH, I_{AS} = 16A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25 $^\circ\!\!C$

3. I_{SD} \leq 50A, di/dt \leq 200A/µs, V_{DD} \leq B_{VDSS}, Starting T_J = 25 °C

4. Pulse width \leq 300µs; duty cycle \leq 2%.

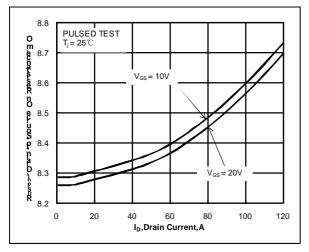
5. This is a typical value at device destruction and represents operation outside rated limits.

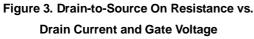
6. This is a calculated value limited to TJ = 175 °C.



Typical Performance Characteristics

Figure 1. Output Characteristics





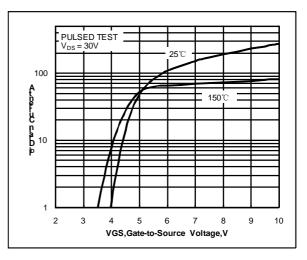


Figure 2. Transfer Characteristics

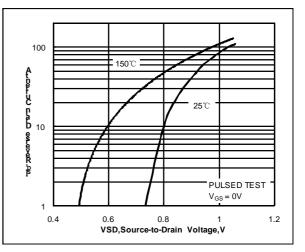
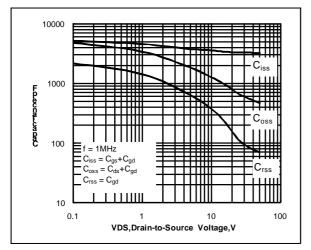
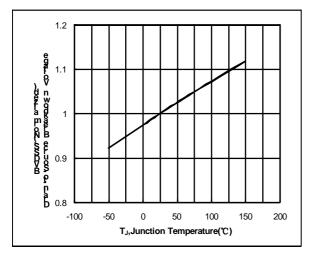
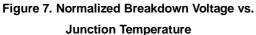


Figure 4. Body Diode Forward Voltage vs. Source Current and Temperature



igure 5. Capacitance Characteristics





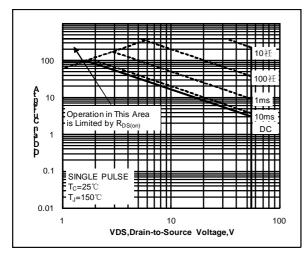


Figure 9. Maximum Safe Operating Area for OP1010A

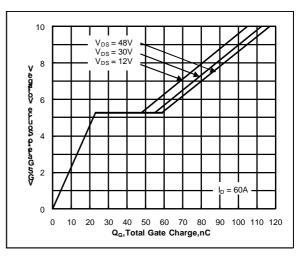
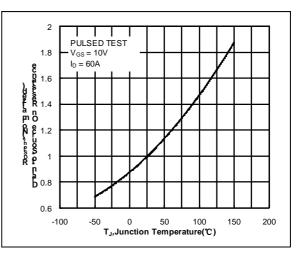


Figure 6. Gate Charge Characteristics





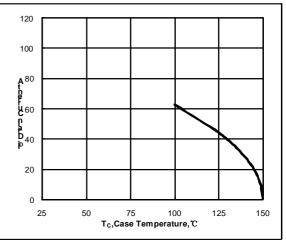


Figure 10. Maximum Continuous Drain Current vs. Case Temperature

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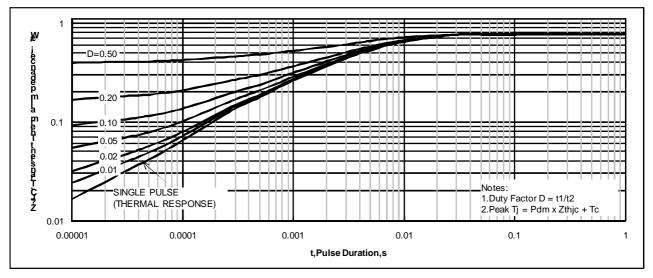
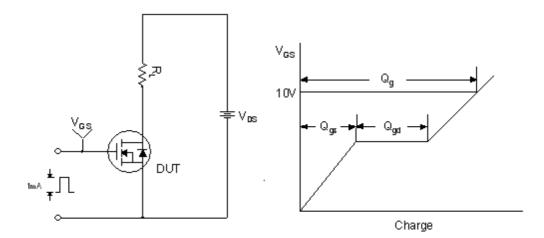


Figure 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case for OP1010A





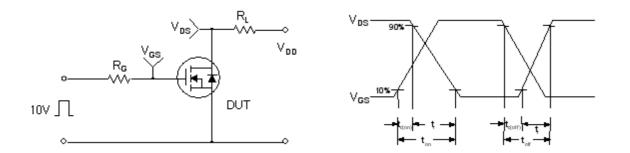


Figure 13. Resistive Switching Test Circuit & Waveforms

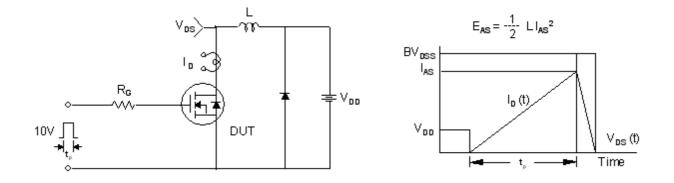
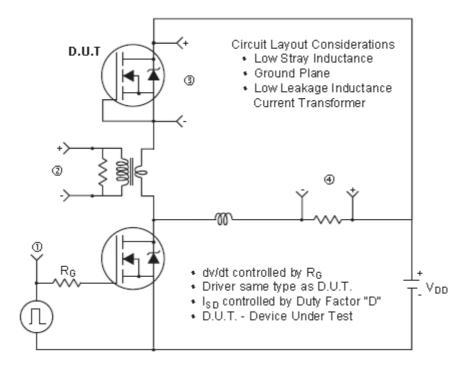
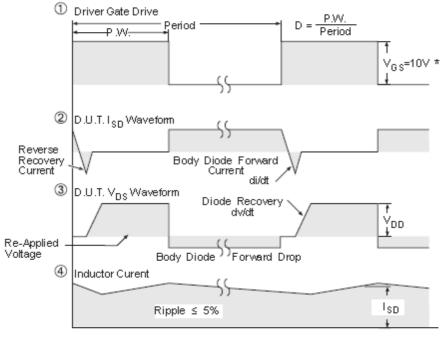


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms





* V_{GS} = 5V for Logic Level Devices



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